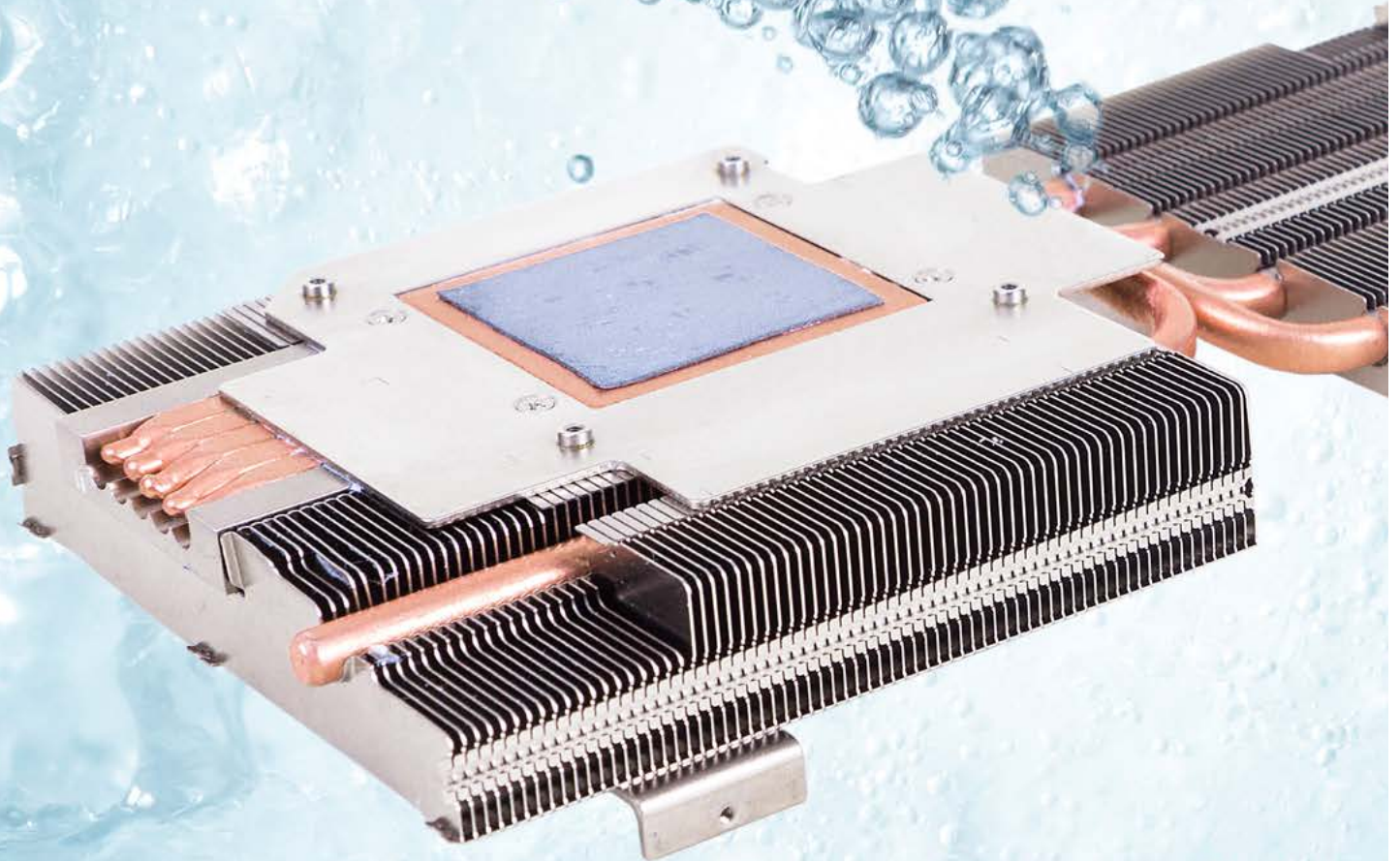


HEATPIPE ASSEMBLIES THERMAL MANAGEMENT

MAKING YOUR HEATPIPE ASSEMBLY MOST
EFFICIENT AND THERMALLY BEST



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MODULAR CONCEPTS

HALA High Performing Contacting Interface Materials

Phase Change films

- TPC-Y-PC
- TPC-W-PC
- TPC-T-AL-CB
- TPC-R-AL

Graphite foil

- TFO-S-CB

Silicone foil

- TEL-Z-SI

Silicone grease

- TGR-S-SI

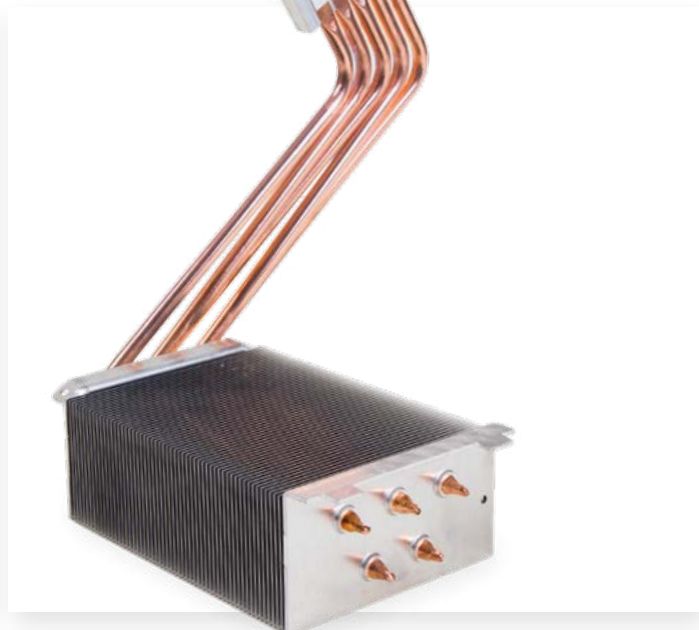
Graphite foil / pyrolytic

- TFO-Y-PG
- TFO-ZS-PG

- TEL-ZS-SI

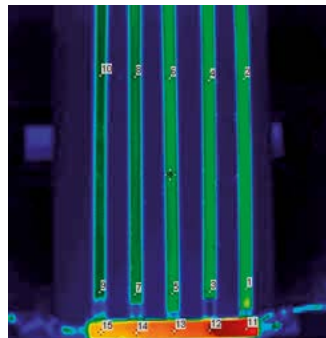
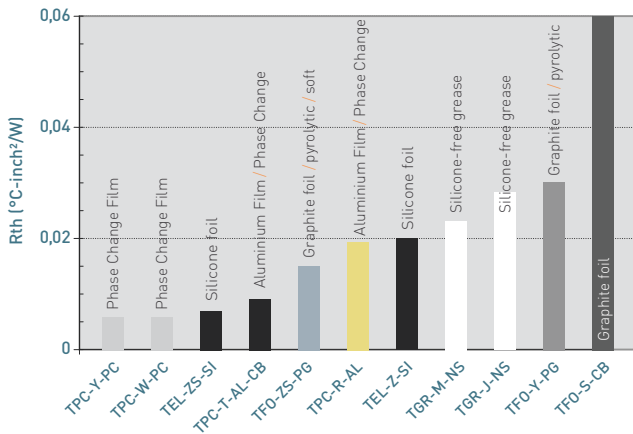
Silicone-free grease

- TGR-J-NS
- TGR-M-NS



Release 11 / 2024

ΔT DATA



CREATING

- Maximum thermal contact
- Minimized thermal resistance
- Compensating mechanic tolerances
- Enhancing efficiency

BENEFITS

- Increasing long-term reliability
- Homogenizing temperatures
- Pre-applied dry-to-the-touch

All technical data and information are without warranty and believed to be reliable and accurate corresponding to the latest state of the art. Since the products are not provided to conform with mutually agreed specifications, and their use and processing are unknown we cannot guarantee results, freedom from patent infringement, or their suitability for any application. Product testing by the applicant is recommended. We reserve the right of changes.